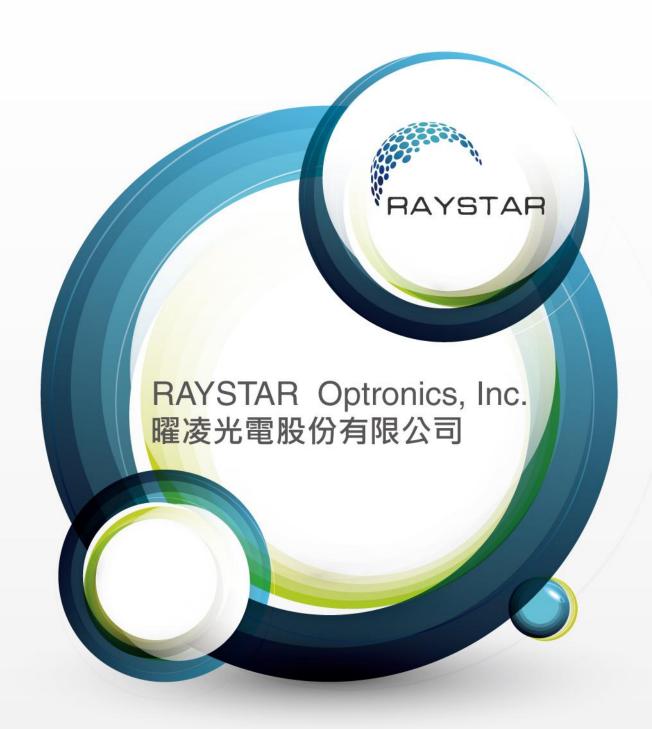
OLED DISPLAY SPECIFICATION





曜凌光電股份有限公司 Raystar Optronics, Inc.

T: +886-4-2565-0761 | F: +886-4-2565-0760

sales@raystar-optronics.com | www.raystar-optronics.com

SPECIFICATION

Model No:

REX012864LSAP3N00000

CUSTOMER:

APPROVED BY	
PCB VERSION	
DATE	

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

Release DATE:

APPROVAL	FOR S	PECIFIC/	ATIONS	ONLY
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☐ APPROVAL FOR SPECIFICATIONS AND SAMPLE



Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2016/02/25		First release
Α	2016/06/01		Modify Static
			electricity test
В	2016/12/07		Modify Interface
С	2017/12/07		Modify Reliability test
			Condition
D	2018/11/22		Modify Static
			electricity test
			Content of Test
E	2019/09/02		Modify Precautions in
			use of OLED Modules
F	2019/12/18		Modify Reliability Test
			and measurement
			conditions &
			Inspection
			specification:" Accept
			no dense" modify to
			"ignore"& Precautions
G	2020/07/14		Modify Contrast Ratio
Н	2020/11/18		Modify Storage
			Precautions



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- 1.General Specification
- 2. Module Classification Information
- 3.Interface Pin Function
- 4. Contour Drawing & Block Diagram
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- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of OLED Modules



1.General Specification

The Features is described as follow:

■ Module dimension: 34.50 x 23.00 x 1.65 mm

■ Active area: 29.42 x 14.20 mm

■ Dot Matrix: 128 x 64

Pixel size: 0.205 x 0.197 mm
 Pixel pitch: 0.230 x 0.222 mm
 Display Mode: Passive Matrix

■ Duty: 1/64 Duty

■ Display Color: SKY BLUE

■ IC: SH1106G

■ Interface: 6800,8080,SPI,I2C

■ Size: 1.28 inch



2. Module Classification information

1	2	3	4	5	6	7	8	9	10	11	12	13	14
R	Е	Х	012864	L	S	Α	Р	3	N	0	0	0	00

1	Brand : Raysta	r Optronics Ind).				
2	E:OLED						
3	Display Type	C : COB Character X : COG P : COG + FR + PCB A : COG + PCB				DB Graphic DG + FR B	
4	Dot Matrix: 1	28*64					
5	Series						
6	Emitting Color	A: Amb B: Blue G: Gre S: Sky	en en	R: Red W: White Y: Yellow X: Dual Color	(C : Full Color	
7	Polarizer Polarizer; N: Without Polarizer A: Anti-glare Polarizer						
8	Display Mode			; N : Active Matri	X		
9	Driver Voltage	3:3.0~	3.3V ; 5	: 5.0V			
10	Touch Panel	N : With	out touch p	panel; T: With toud	ch panel		
11	Product type	0 : Standard 1 : Daylight Readable					
12	Inspection Gra	0 : Stan 2 : B gra C : Auto Y : Con	dard ade omotive gra sumer grad	le			
13	Option			FPC;H:Hot ba	ar FPC;	D: Demo Kit	
14	Serial No.	Serial n	umber(00~2	ZZ)	10		



3. Interface Pin Function

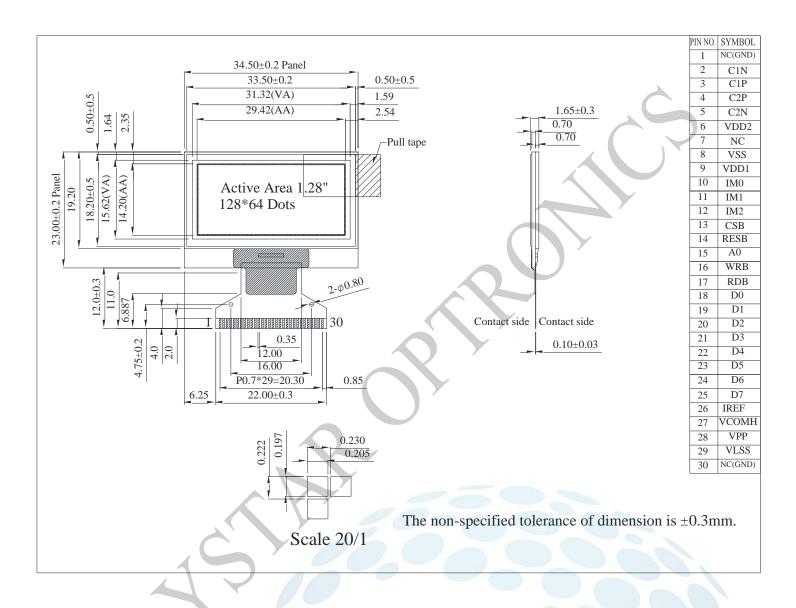
No.	Symbol	Function							
1	NC(GND)	No conne	No connection						
2	C1N			ımp capacito					
3	C1P	These pinexternally		sed and shou	ıld be discor	nnected when	Vpp is supp	lied	
4	C2P			ımp capacito					
5	C2N	externally	y .			nnected when		lied	
6	VDD2					for charge p supplied exte			
7	NC	No conne	ection						
8	VSS	Ground.					•		
9	VDD1		ipply input: 1						
10	IM0	These ar	e the MPU ir	nterface mod	e select pac	ls.			
			8080	I ² C	6800	4-wire SPI	3-wire SPI		
11	IM1	IM0	0	0	0	0	1		
		IM1	1	1	0	0	0		
12	IM2	IM2	1	0	1	0	0		
13	CSB	active,		elect input. V O is enabled		"L", then the	chip select t	pecomes	
14	RESB	The rese	t			set to "L", the	settings are	initialized.	
15	A0	A0 = "L": the inputs at D0 to D7 are transferred to the command registers. In I2C interface, this pad serves as SA0 to distinguish the different address of							
16	WRB	In I2C interface, this pad serves as SA0 to distinguish the different address of OLED driver. This is a MPU interface input pad. When connected to an 8080 MPU, this is active LOW. This pad connects to the 8080 MPU WR signal. The signals on the data bus are latched at the rising edge of the WR signal. When connected to a 6800 Series MPU: This is the read/write control signal input terminal. When R/W = "H": Read.							
		When R/	W = L: Writ	ie.		1000		- 11	



		This is a MPU interface input pad.
		When connected to an 8080 series MPU, it is active LOW. This pad is connected to the RD signal
		of the 8080 series MPU, and the data bus is in an output status when this signal is
	222	"L".
17	RDB	When connected to a 6800 series MPU, this is active HIGH. This is used as an
		enable clock
		input of the 6800 series MPU.
		When RD = "H": Enable.
		When RD = "L": Disable.
18	D0	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit standard
19	D1	MPU data bus.
20	D2	When the serial interface is selected, then D0 serves as the serial clock input pad
21	D3	(SCL) and D1
22	D4	serves as the serial data input pad (SI). At this time, D2 to D7 are set to high
23	D5	impedance.
24	D6	When the I2C interface is selected, then D0 serves as the serial clock input pad
0.5	D-7	(SCL) and D1 serves as the serial data input pad (SDAI). At this time, D2 to D7 are set to high
25	D7	impedance.
		This is a segment current reference pad. A resistor should be connected between
26	IREF	this pad and
		VSS. Set the current at 18.75uA.
27	VCOMH	This is a pad for the voltage output high level for common signals.
21	V O O IVII I	A capacitor should be connected between this pad and VSS.
28	VPP	OLED panel power supply. Generated by internal charge pump.
	V 1 1	Connect to capacitor. It could be supplied externally.
29	VLSS	This is a segment voltage reference pad.
		This pad should be connected to VSS externally.
30	NC(GND)	No connection
	·	

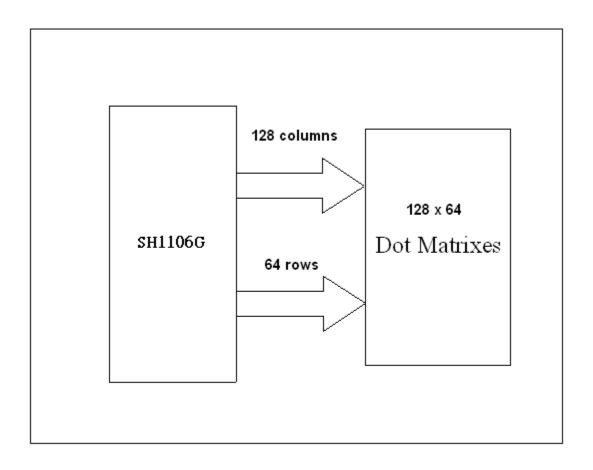


4. Contour Drawing & Block Diagram





FUNCTION BLOCK DIAGRAM



*For more information, please refer to Application Note provided by Raystar Optronics.



5.Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage for Logic	VDD1	-0.3	3.6	V
Power supply for charge pump circuit	VDD2	-0.3	4.8	V
Supply Voltage for Display	VPP	-0.3	14.5	V
Operating Temperature	TOP	-40	+80	°C
Storage Temperature	TSTG	-40	+85	°C



6.Electrical Characteristics

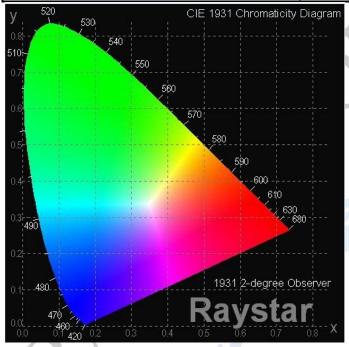
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	_	7	7.25	7.5	V
High Level Input	VIH	_	0.8VDD	_	VDD	V
Low Level Input	VIL	_	VSS	-4	0.2VDD	V
High Level Output	VOH	_	0.8VDD		VDD	V
Low Level Input	VOL	_	VSS	-	0.2VDD	V
50% Check Board operating C	VCC =7.25V	5	6	7	mA	



7. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ	_	160	_	_	deg
view / trigic	(Η)φ	_	160	_	-	deg
Contrast Ratio	CR	Dark	10,000:1	-		
Response Time	T rise	_	_	10		μs
Treeponde Time	T fall	_	_	10		μs
Display with 50% check E	80	100	_	cd/m2		
CIEx(Sky blue)	0.12	0.16	0.20	_		
CIEy(Sky blue)		(CIE1931)	0.22	0.26	0.30	_

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8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value	20,000 Hrs	-	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.

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3. Screen saving mode will extend OLED lifetime.





9.Reliability

Content of Reliability Test

Environmental Test Content of Test Test Condition Applicable				
Test Item	Content or rest	rest Condition	Standard	
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85℃ 240hrs	- (
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40℃ 240hrs	4	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80℃ 240hrs		
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40℃ 240hrs		
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60℃,90%RH 240hrs		
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60℃,90%RH 120hrs		
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min 1 cycle	-40°C/80°C 30 cycles	287	
Mechanical Tes	st C			
Vibration test Endurance test applying the vibration during transportation and using.		Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z		
Others				
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv,10 times		

^{***} Supply voltage for OLED system =Operating voltage at 25 $^{\circ}\mathrm{C}$



Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels on/off exchange is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



10.Inspection specification

 Electrical Testing 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. Black or white 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.
1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 2.1 White and black spots on display ≤0.25mm, no more than
1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 02 Black or 2.1 White and black spots on display ≤0.25mm, no more than
 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. D2 Black or 2.1 White and black spots on display ≤0.25mm, no more than
 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. D2 Black or 2.1 White and black spots on display ≤0.25mm, no more than
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1.8 Contrast defect. 02 Black or 2.1 White and black spots on display ≤0.25mm, no more than
02 Black or 2.1 White and black spots on display ≤0.25mm, no more than
· · · · · · · · · ·
· · · · · · · · · ·
snots on 2.2 Densely spaced. No more than two spots or lines within
OLED 3mm.
(display
only)
03 OLED 3.1 Round type : As
black following drawing SIZE Acceptable
spots, $\Phi=(x+y)/2$ $\Phi \le 0.10$ ignore
1
spots, $0.10 < 2$ 0.5
tion $\psi \equiv 0.20$
$\left \begin{array}{c} \text{(non-displ} \end{array}\right $
$\Phi \leq 0.25$
0.25<Φ
3.2 Line type : (As following drawing)
Length Width Acceptable Q TY
$\frac{1}{\sqrt{30}} = \frac{W}{\sqrt{300}} = \frac{W}{\sqrt{3000}} =$
$L \le 2.5 0.03 < W \le 0.05 $
0.05 <w as="" round="" td="" type<=""></w>
04 Polarizer
bubbles If bubbles are visible, Size Φ Acceptable Q TY
judge using black spot φ≤0.20 ignore
specifications, not easy $0.20 < \Phi \le 0.50$ 3 2.5
to find, must check in $0.50 < \phi < 1.00$
specify direction. $\frac{0.50 < \Phi = 1.00}{1.00 < \Phi}$
Total Q TY 3



NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination	
		Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length:	
		6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:	
06	Chipped glass		2.5
6.1.2 Corner crack:		6.1.2 Corner crack:	
			2
	_	z: Chip thickness y: Chip width x: Chip length	
		Z≦1/2t Not over viewing x≤1/8a area	
		1/2t < z ≤ 2t Not exceed 1/3k x ≤ 1/8a	
		⊙ If there are 2 or more chips, x is the total length of each chip.	



NO	Item	Criterion	AQL	
		Symbols:		
		x: Chip length y: Chip width z: Chip thickness		
		k: Seal width t: Glass thickness a: OLED side length		
		L: Electrode pad length		
	6.2 Protrusion over terminal : 6.2.1 Chip on electrode pad :			
		_ ī		
		A Day 2) `	
		13300		
		A A X		
		y: Chip width x: Chip length z: Chip thickness		
		$y \le 0.5$ mm $x \le 1/8$ a $0 < z \le t$		
		6.2.2 Non-conductive portion:		
	Glass			
06	crack	12	2.5	
		y Y		
		X -SY,		
		V		
		y: Chip width x: Chip length z: Chip		
		$ \begin{array}{c cccc} & & \text{thickness} \\ \hline y \leq L & x \leq 1/8a & 0 < z \leq t \end{array} $		
		\bigcirc If the chipped area touches the ITO terminal, over 2/3 of the ITO		
		must remain and be inspected according to electrode terminal		
		specifications.		
		⊙If the product will be heat sealed by the customer, the alignment		
		mark not be damaged.		
		6.2.3 Substrate protuberance and internal crack.		
	-	y: width x: length		
		y≤1/3L x ≤ a		
		y s		
			3	
			366	



NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	2.5 2.5 0.65 2.5 2.5 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65



NO	Item	Criterion	AQL
		 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 	2.5 0.65 2.5 2.5
40	General appearance	12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.	2.5
12		12.6 The residual rosin or tin oil of soldering (component or	2.5
		chip component) is not burned into brown or black color.	0.65 0.65
		12.7 Sealant on top of the ITO circuit has not hardened.12.8 Pin type must match type in specification sheet.	0.65
		12.9 OLED pin loose or missing pins.	0.00
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	



Check Item	Classification	Criteria			
No Display	Major				
Missing Line	Major				
Pixel Short	Major				
Darker Short	Major				
Wrong Display	Major				
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major				
7		A Normal B Dark Fixel C Light Fixel			



11.Precautions in use of OLED Modules

Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, change the components or modify its shape of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Do not apply input signals while the logic power is off.
- (5) Don't operate it above the absolute maximum rating.
- (6) Don't drop, bend or twist OLED display module.
- (7) Soldering: only to the I/O terminals.
- (8) Hot-Bar FPC soldering condition: 280~350C, less than 5 seconds.
- (9) Raystar has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.) and change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Raystar have the right to modify the version.)
- (10) Raystar has the right to upgrade or modify the product function.

11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged. So, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent

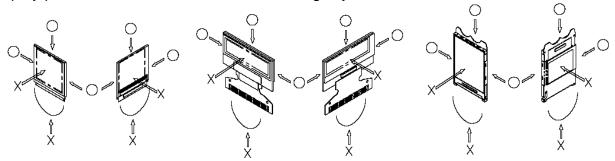
Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (7) Do not touch the following sections whenever possible while handling the OLED display modules.
 - * Pins and electrodes
 - * Pattern layouts such as the TCP & FPC
- (8) Hold OLED display module very carefully when placing OLED display module into the



System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (9) Do not apply stress to the LSI chips and the surrounding molded sections.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OLED display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

11.2. Storage Precautions

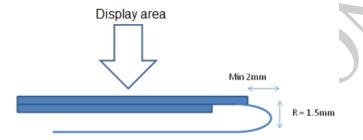
- (1) When storing OLED display modules, put them in static electricity preventive bags to avoid be directly exposed to sun or lights of fluorescent lamps. And, also, place in the temperature 25±5°C and Humidity below 65% RH.(We recommend you to store these modules in the packaged state when they were shipped from Winstar. At that time, be careful not to let water drops adhere to the packages or bags.)
- (2) When the OLED display module is being dewed or when it is placed under high temperature or high humidity environments, the electrodes may be corroded if electric current is applied. Please store it in clean environment.

11.3. Designing Precautions

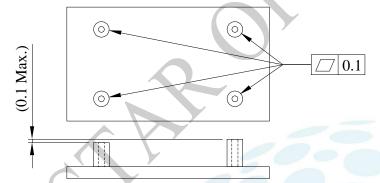
- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, OLED display module may be damaged.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specification and to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD / VCC). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the nearby devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) If the power supplied to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.



- * Connection (contact) to any other potential than the above may lead to rupture of the IC.
- (7) If this OLED driver is exposed to light, malfunctioning may occur and semiconductor elements may change their characteristics.
- (8) The internal status may be changed, if excessive external noise enters into the module. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect module from influences of noise on the system design.
- (9) We recommend you to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (10) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use the same image for long time in real application. When an OLED display module is operated for a long of time with fixed pattern, an afterimage or slight contrast deviation may occur.
- (11) The limitation of FPC and Film bending.



(12) The module should be fixed balanced into the housing, or the module may be twisted.



(13) Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

11.4. Precautions when disposing of the OLED display modules

(1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.





Page: 1

Module Sample Estimate Feedback Sheet			
Module Number :			
1 · Panel Specification :			
1. Panel Type:	□ Pass	□NG ,	
2. Numbers of Pixel : □ Pas		□NG ,	
3. View Area:	□ Pass	□NG ,	
4. Active Area:	□ Pass	□NG ,	
5.Emitting Color:	□ Pass	□NG ,	
6.Uniformity:	□Pass	□NG ,	
7.Operating	□ Pass	□NG ,	
Temperature :		, y	
8.Storage Temperature:	□ Pass	□NG ,	
9.Others:	1		
2 · Mechanical Specificati	<u>on</u> :		
1. PCB Size:	□Pass	□NG ,	
2.Frame Size :	□Pass	□NG ,	
3.Materal of Frame:	□Pass	□NG ,	
4.Connector Position:	□Pass	□NG ,	
5.Fix Hole Position:	□Pass	□NG ,	
6. Thickness of PCB:	□Pass	□NG ,	
7. Height of Frame to	□Pass	□NG ,	
PCB:			
8.Height of Module:	□Pass	□NG ,	
9.Others:	□Pass	□NG ,	
3 · Relative Hole Size :			
1.Pitch of Connector:	□Pass	□NG ,	
2.Hole size of □Pas		□NG ,	
Connector:			
3.Mounting Hole size : □Pass		□NG ,	
4.Mounting Hole Type:	□Pass	□NG ,	
5.Others : □Pass		□NG .	

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Module Number :				
4 · Electronic Characteristics of Module :				
1.Input Voltage:	□Pass	□NG ,		
2.Supply Current:	□Pass	□NG ,		
3.Driving Voltage for □Pass OLED:		□NG ,		
4.Contrast for OLED:	□Pass	□NG ,		
5.Negative Voltage Output:	□Pass	□NG ,		
6.Interface Function:	□Pass	□NG ,		
7.ESD test:	□Pass	□NG ,		
8.Others:	□Pass	□NG ,		
Sales signature : Customer Signature	:			
Customer Signature				